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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	dsPIC
Core Size	16-Bit
Speed	60 MIPS
Connectivity	CANbus, I <sup>2</sup> C, IrDA, LINbus, QEI, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, Motor Control PWM, POR, PWM, WDT
Number of I/O	35
Program Memory Size	128KB (43K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 16
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 9x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 150°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VFTLA Exposed Pad
Supplier Device Package	44-VTLA (6x6)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/dspic33ep128mc504-h-tl">https://www.e-xfl.com/product-detail/microchip-technology/dspic33ep128mc504-h-tl</a>

### 3.7 CPU Control Registers

**REGISTER 3-1: SR: CPU STATUS REGISTER**

R/W-0	R/W-0	R/W-0	R/W-0	R/C-0	R/C-0	R-0	R/W-0
OA <sup>(1)</sup>	OB <sup>(1)</sup>	SA <sup>(1,4)</sup>	SB <sup>(1,4)</sup>	OAB <sup>(1)</sup>	SAB <sup>(1)</sup>	DA <sup>(1)</sup>	DC
bit 15							bit 8

R/W-0 <sup>(2,3)</sup>	R/W-0 <sup>(2,3)</sup>	R/W-0 <sup>(2,3)</sup>	R-0	R/W-0	R/W-0	R/W-0	R/W-0
IPL2	IPL1	IPL0	RA	N	OV	Z	C
bit 7							bit 0

<b>Legend:</b>	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- bit 15      **OA:** Accumulator A Overflow Status bit<sup>(1)</sup>  
              1 = Accumulator A has overflowed  
              0 = Accumulator A has not overflowed
- bit 14      **OB:** Accumulator B Overflow Status bit<sup>(1)</sup>  
              1 = Accumulator B has overflowed  
              0 = Accumulator B has not overflowed
- bit 13      **SA:** Accumulator A Saturation 'Sticky' Status bit<sup>(1,4)</sup>  
              1 = Accumulator A is saturated or has been saturated at some time  
              0 = Accumulator A is not saturated
- bit 12      **SB:** Accumulator B Saturation 'Sticky' Status bit<sup>(1,4)</sup>  
              1 = Accumulator B is saturated or has been saturated at some time  
              0 = Accumulator B is not saturated
- bit 11      **OAB:** OA || OB Combined Accumulator Overflow Status bit<sup>(1)</sup>  
              1 = Accumulators A or B have overflowed  
              0 = Neither Accumulators A or B have overflowed
- bit 10      **SAB:** SA || SB Combined Accumulator 'Sticky' Status bit<sup>(1)</sup>  
              1 = Accumulators A or B are saturated or have been saturated at some time  
              0 = Neither Accumulators A or B are saturated
- bit 9        **DA:** DO Loop Active bit<sup>(1)</sup>  
              1 = DO loop is in progress  
              0 = DO loop is not in progress
- bit 8        **DC:** MCU ALU Half Carry/Borrow bit  
              1 = A carry-out from the 4th low-order bit (for byte-sized data) or 8th low-order bit (for word-sized data) of the result occurred  
              0 = No carry-out from the 4th low-order bit (for byte-sized data) or 8th low-order bit (for word-sized data) of the result occurred

- Note 1:** This bit is available on dsPIC33EPXXXMC20X/50X and dsPIC33EPXXXGP50X devices only.
- Note 2:** The IPL<2:0> bits are concatenated with the IPL<3> bit (CORCON<3>) to form the CPU Interrupt Priority Level. The value in parentheses indicates the IPL, if IPL<3> = 1. User interrupts are disabled when IPL<3> = 1.
- Note 3:** The IPL<2:0> Status bits are read-only when the NSTDIS bit (INTCON1<15>) = 1.
- Note 4:** A data write to the SR register can modify the SA and SB bits by either a data write to SA and SB or by clearing the SAB bit. To avoid a possible SA or SB bit write race condition, the SA and SB bits should not be modified using bit operations.

Allocating different Page registers for read and write access allows the architecture to support data movement between different pages in data memory. This is accomplished by setting the DSRPAG register value to the page from which you want to read, and configuring the DSWPAG register to the page to which it needs to be written. Data can also be moved from different PSV to EDS pages, by configuring the DSRPAG and DSWPAG registers to address PSV and EDS space, respectively. The data can be moved between pages by a single instruction.

When an EDS or PSV page overflow or underflow occurs, EA<15> is cleared as a result of the register indirect EA calculation. An overflow or underflow of the EA in the EDS or PSV pages can occur at the page boundaries when:

- The initial address prior to modification addresses an EDS or PSV page
- The EA calculation uses Pre-Modified or Post-Modified Register Indirect Addressing; however, this does not include Register Offset Addressing

In general, when an overflow is detected, the DSxPAG register is incremented and the EA<15> bit is set to keep the base address within the EDS or PSV window. When an underflow is detected, the DSxPAG register is decremented and the EA<15> bit is set to keep the base address within the EDS or PSV window. This creates a linear EDS and PSV address space, but only when using Register Indirect Addressing modes.

Exceptions to the operation described above arise when entering and exiting the boundaries of Page 0, EDS and PSV spaces. Table 4-61 lists the effects of overflow and underflow scenarios at different boundaries.

In the following cases, when overflow or underflow occurs, the EA<15> bit is set and the DSxPAG is not modified; therefore, the EA will wrap to the beginning of the current page:

- Register Indirect with Register Offset Addressing
- Modulo Addressing
- Bit-Reversed Addressing

**TABLE 4-61: OVERFLOW AND UNDERFLOW SCENARIOS AT PAGE 0, EDS and PSV SPACE BOUNDARIES<sup>(2,3,4)</sup>**

O/U, R/W	Operation	Before			After		
		DSxPAG	DS EA<15>	Page Description	DSxPAG	DS EA<15>	Page Description
O, Read	[ ++Wn ] or [ Wn++ ]	DSRPAG = 0x1FF	1	EDS: Last page	DSRPAG = 0x1FF	0	See <b>Note 1</b>
O, Read		DSRPAG = 0x2FF	1	PSV: Last lsw page	DSRPAG = 0x300	1	PSV: First MSB page
O, Read		DSRPAG = 0x3FF	1	PSV: Last MSB page	DSRPAG = 0x3FF	0	See <b>Note 1</b>
O, Write		DSWPAG = 0x1FF	1	EDS: Last page	DSWPAG = 0x1FF	0	See <b>Note 1</b>
U, Read	[ --Wn ] or [ Wn-- ]	DSRPAG = 0x001	1	PSV page	DSRPAG = 0x001	0	See <b>Note 1</b>
U, Read		DSRPAG = 0x200	1	PSV: First lsw page	DSRPAG = 0x200	0	See <b>Note 1</b>
U, Read		DSRPAG = 0x300	1	PSV: First MSB page	DSRPAG = 0x2FF	1	PSV: Last lsw page

**Legend:** O = Overflow, U = Underflow, R = Read, W = Write

**Note 1:** The Register Indirect Addressing now addresses a location in the base Data Space (0x0000-0x8000).

**2:** An EDS access with DSxPAG = 0x000 will generate an address error trap.

**3:** Only reads from PS are supported using DSRPAG. An attempt to write to PS using DSWPAG will generate an address error trap.

**4:** Pseudo-Linear Addressing is not supported for large offsets.

**REGISTER 8-11: DMAPWC: DMA PERIPHERAL WRITE COLLISION STATUS REGISTER**

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15				bit 8			

U-0	U-0	U-0	U-0	R-0	R-0	R-0	R-0
—	—	—	—	PWCOL3	PWCOL2	PWCOL1	PWCOL0
bit 7				bit 0			

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-4      **Unimplemented:** Read as '0'

bit 3      **PWCOL3:** DMA Channel 3 Peripheral Write Collision Flag bit

1 = Write collision is detected

0 = No write collision is detected

bit 2      **PWCOL2:** DMA Channel 2 Peripheral Write Collision Flag bit

1 = Write collision is detected

0 = No write collision is detected

bit 1      **PWCOL1:** DMA Channel 1 Peripheral Write Collision Flag bit

1 = Write collision is detected

0 = No write collision is detected

bit 0      **PWCOL0:** DMA Channel 0 Peripheral Write Collision Flag bit

1 = Write collision is detected

0 = No write collision is detected

## 9.0 OSCILLATOR CONFIGURATION

**Note 1:** This data sheet summarizes the features of the dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X families of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to “**Oscillator**” (DS70580) in the “*dsPIC33/PIC24 Family Reference Manual*”, which is available from the Microchip web site ([www.microchip.com](http://www.microchip.com)).

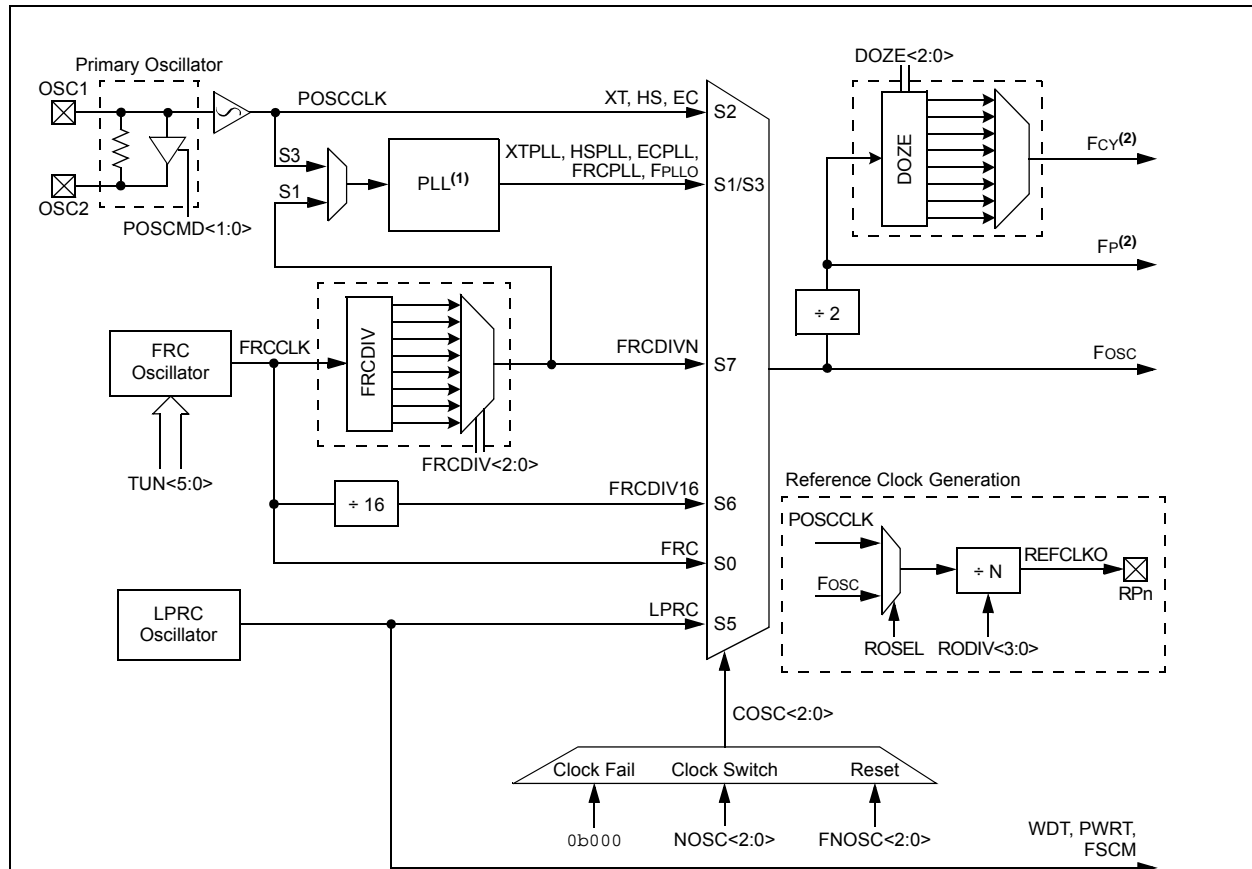
**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

The dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X oscillator system provides:

- On-chip Phase-Locked Loop (PLL) to boost internal operating frequency on select internal and external oscillator sources
- On-the-fly clock switching between various clock sources
- Doze mode for system power savings
- Fail-Safe Clock Monitor (FSCM) that detects clock failure and permits safe application recovery or shutdown
- Configuration bits for clock source selection

A simplified diagram of the oscillator system is shown in Figure 9-1.

**FIGURE 9-1: OSCILLATOR SYSTEM DIAGRAM**



**Note 1:** See Figure 9-2 for PLL details.

**2:** The term, Fp, refers to the clock source for all peripherals, while Fcy refers to the clock source for the CPU. Throughout this document, Fcy and Fp are used interchangeably, except in the case of Doze mode. Fp and Fcy will be different when Doze mode is used with a doze ratio of 1:2 or lower.

**REGISTER 9-1: OSCCON: OSCILLATOR CONTROL REGISTER<sup>(1)</sup> (CONTINUED)**

bit 4	<b>Unimplemented:</b> Read as '0'
bit 3	<b>CF:</b> Clock Fail Detect bit <sup>(3)</sup> 1 = FSCM has detected clock failure 0 = FSCM has not detected clock failure
bit 2-1	<b>Unimplemented:</b> Read as '0'
bit 0	<b>OSWEN:</b> Oscillator Switch Enable bit 1 = Requests oscillator switch to selection specified by the NOSC<2:0> bits 0 = Oscillator switch is complete

- Note 1:** Writes to this register require an unlock sequence. Refer to “**Oscillator**” (DS70580) in the “*dsPIC33/PIC24 Family Reference Manual*” (available from the Microchip web site) for details.
- 2:** Direct clock switches between any primary oscillator mode with PLL and FRCPLL mode are not permitted. This applies to clock switches in either direction. In these instances, the application must switch to FRC mode as a transitional clock source between the two PLL modes.
- 3:** This bit should only be cleared in software. Setting the bit in software (= 1) will have the same effect as an actual oscillator failure and trigger an oscillator failure trap.

**REGISTER 11-2: RPINR1: PERIPHERAL PIN SELECT INPUT REGISTER 1**

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
—	INT2R<6:0>							
bit 7								bit 0

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6-0 **INT2R<6:0>:** Assign External Interrupt 2 (INT2) to the Corresponding RPn Pin bits  
(see Table 11-2 for input pin selection numbers)

1111001 = Input tied to RPI121

.

.

.

0000001 = Input tied to CMP1

0000000 = Input tied to Vss

**REGISTER 11-3: RPINR3: PERIPHERAL PIN SELECT INPUT REGISTER 3**

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
—	T2CKR<6:0>							
bit 7								bit 0

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6-0 **T2CKR<6:0>:** Assign Timer2 External Clock (T2CK) to the Corresponding RPn pin bits  
(see Table 11-2 for input pin selection numbers)

1111001 = Input tied to RPI121

.

.

.

0000001 = Input tied to CMP1

0000000 = Input tied to Vss

FIGURE 13-1: TYPE B TIMER BLOCK DIAGRAM (x = 2 AND 4)

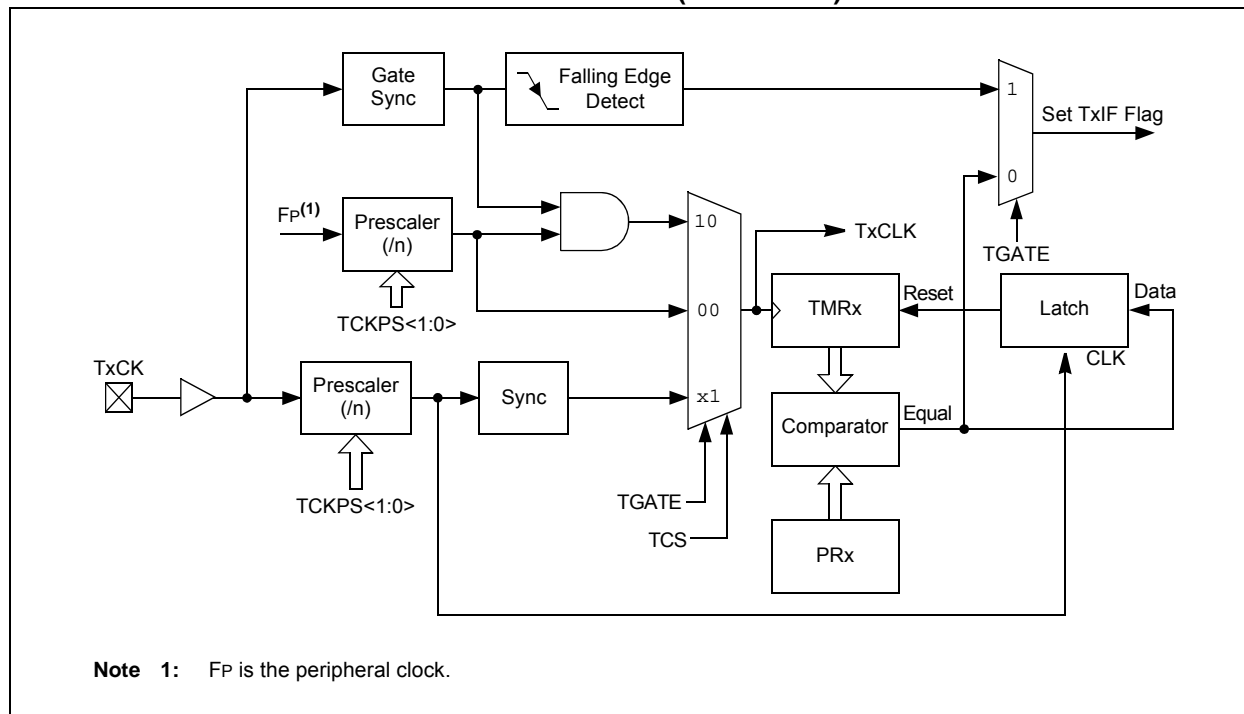
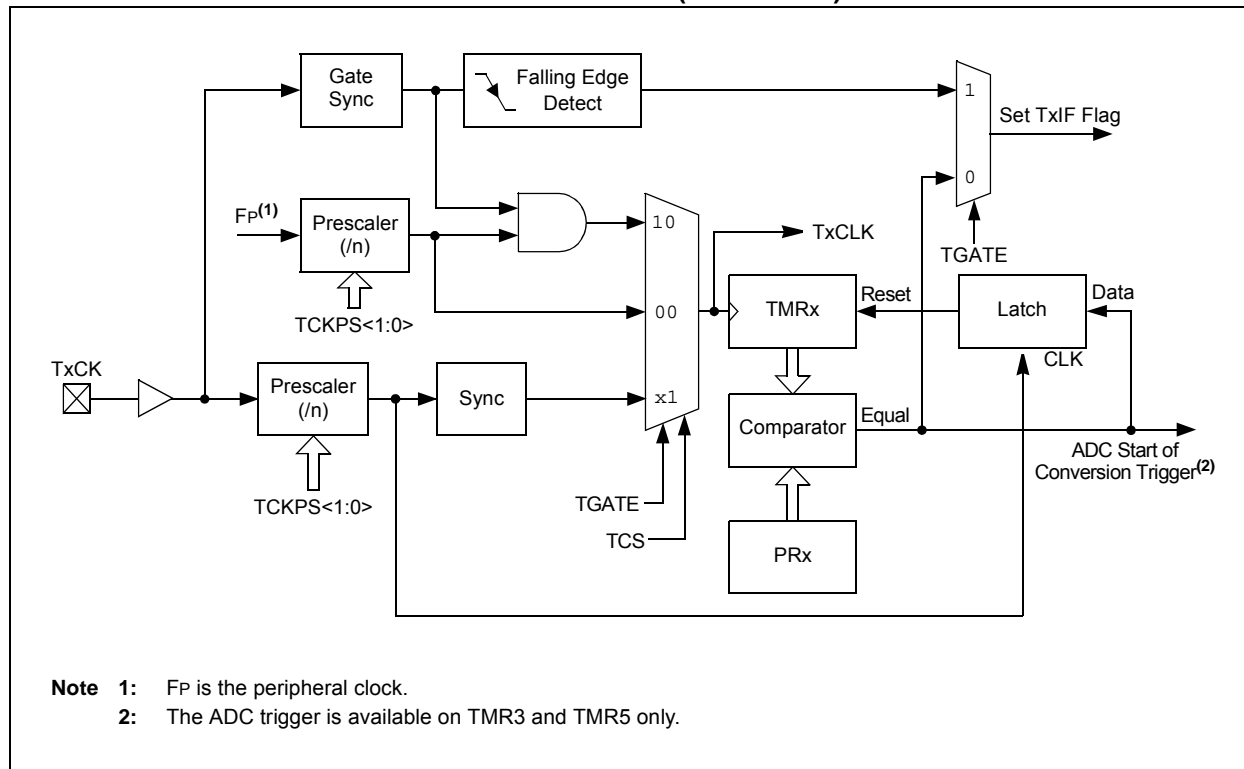


FIGURE 13-2: TYPE C TIMER BLOCK DIAGRAM (x = 3 AND 5)





## 14.1 Input Capture Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

**Note:** In the event you are not able to access the product page using the link above, enter this URL in your browser:  
<http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en555464>

### 14.1.1 KEY RESOURCES

- **“Input Capture”** (DS70352) in the *“dsPIC33/PIC24 Family Reference Manual”*
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related *“dsPIC33/PIC24 Family Reference Manual”* Sections
- Development Tools

**REGISTER 15-2: OCxCON2: OUTPUT COMPARE x CONTROL REGISTER 2 (CONTINUED)**

bit 4-0      **SYNCSEL<4:0>**: Trigger/Synchronization Source Selection bits

11111 = OCxRS compare event is used for synchronization  
 11110 = INT2 pin synchronizes or triggers OCx  
 11101 = INT1 pin synchronizes or triggers OCx  
 11100 = CTMU module synchronizes or triggers OCx  
 11011 = ADC1 module synchronizes or triggers OCx  
 11010 = CMP3 module synchronizes or triggers OCx  
 11001 = CMP2 module synchronizes or triggers OCx  
 11000 = CMP1 module synchronizes or triggers OCx  
 10111 = Reserved  
 10110 = Reserved  
 10101 = Reserved  
 10100 = Reserved  
 10011 = IC4 input capture event synchronizes or triggers OCx  
 10010 = IC3 input capture event synchronizes or triggers OCx  
 10001 = IC2 input capture event synchronizes or triggers OCx  
 10000 = IC1 input capture event synchronizes or triggers OCx  
 01111 = Timer5 synchronizes or triggers OCx  
 01110 = Timer4 synchronizes or triggers OCx  
 01101 = Timer3 synchronizes or triggers OCx  
 01100 = Timer2 synchronizes or triggers OCx **(default)**  
 01011 = Timer1 synchronizes or triggers OCx  
 01010 = PTGOx synchronizes or triggers OCx<sup>(3)</sup>  
 01001 = Reserved  
 01000 = Reserved  
 00111 = Reserved  
 00110 = Reserved  
 00101 = Reserved  
 00100 = OC4 module synchronizes or triggers OCx<sup>(1,2)</sup>  
 00011 = OC3 module synchronizes or triggers OCx<sup>(1,2)</sup>  
 00010 = OC2 module synchronizes or triggers OCx<sup>(1,2)</sup>  
 00001 = OC1 module synchronizes or triggers OCx<sup>(1,2)</sup>  
 00000 = No Sync or Trigger source for OCx

**Note 1:** Do not use the OCx module as its own Synchronization or Trigger source.

**2:** When the OCy module is turned OFF, it sends a trigger out signal. If the OCx module uses the OCy module as a Trigger source, the OCy module must be unselected as a Trigger source prior to disabling it.

**3:** Each Output Compare x module (OCx) has one PTG Trigger/Synchronization source. See **Section 24.0 “Peripheral Trigger Generator (PTG) Module”** for more information.

PTGO0 = OC1

PTGO1 = OC2

PTGO2 = OC3

PTGO3 = OC4

**REGISTER 16-10: DTRx: PWMx DEAD-TIME REGISTER**

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	DTRx<13:8>					
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
DTRx<7:0>							
bit 7							bit 0

**Legend:**

R = Readable bit                      W = Writable bit                      U = Unimplemented bit, read as '0'  
-n = Value at POR                      '1' = Bit is set                      '0' = Bit is cleared                      x = Bit is unknown

bit 15-14                      **Unimplemented:** Read as '0'

bit 13-0                      **DTRx<13:0>:** Unsigned 14-Bit Dead-Time Value for PWMx Dead-Time Unit bits

**REGISTER 16-11: ALTDTRx: PWMx ALTERNATE DEAD-TIME REGISTER**

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	ALTDTRx<13:8>					
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ALTDTRx<7:0>							
bit 7							bit 0

**Legend:**

R = Readable bit                      W = Writable bit                      U = Unimplemented bit, read as '0'  
-n = Value at POR                      '1' = Bit is set                      '0' = Bit is cleared                      x = Bit is unknown

bit 15-14                      **Unimplemented:** Read as '0'

bit 13-0                      **ALTDTRx<13:0>:** Unsigned 14-Bit Dead-Time Value for PWMx Dead-Time Unit bits

## 20.1 UART Helpful Tips

1. In multi-node, direct-connect UART networks, UART receive inputs react to the complementary logic level defined by the URXINV bit (UxMODE<4>), which defines the Idle state, the default of which is logic high (i.e., URXINV = 0). Because remote devices do not initialize at the same time, it is likely that one of the devices, because the RX line is floating, will trigger a Start bit detection and will cause the first byte received, after the device has been initialized, to be invalid. To avoid this situation, the user should use a pull-up or pull-down resistor on the RX pin depending on the value of the URXINV bit.
  - a) If URXINV = 0, use a pull-up resistor on the RX pin.
  - b) If URXINV = 1, use a pull-down resistor on the RX pin.
2. The first character received on a wake-up from Sleep mode caused by activity on the UxRX pin of the UARTx module will be invalid. In Sleep mode, peripheral clocks are disabled. By the time the oscillator system has restarted and stabilized from Sleep mode, the baud rate bit sampling clock, relative to the incoming UxRX bit timing, is no longer synchronized, resulting in the first character being invalid; this is to be expected.

## 20.2 UART Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

**Note:** In the event you are not able to access the product page using the link above, enter this URL in your browser:  
<http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en555464>

### 20.2.1 KEY RESOURCES

- “UART” (DS70582) in the “*dsPIC33/PIC24 Family Reference Manual*”
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related “*dsPIC33/PIC24 Family Reference Manual*” Sections
- Development Tools

## 20.3 UARTx Control Registers

**REGISTER 20-1: UxMODE: UARTx MODE REGISTER**

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
UARTEN <sup>(1)</sup>	—	USIDL	IREN <sup>(2)</sup>	RTSMD	—	UEN1	UEN0
bit 15						bit 8	

R/W-0, HC	R/W-0	R/W-0, HC	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WAKE	LPBACK	ABAUD	URXINV	BRGH	PDSEL1	PDSEL0	STSEL
bit 7						bit 0	

<b>Legend:</b>	HC = Hardware Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- bit 15      **UARTEN:** UARTx Enable bit<sup>(1)</sup>  
 1 = UARTx is enabled; all UARTx pins are controlled by UARTx as defined by UEN<1:0>  
 0 = UARTx is disabled; all UARTx pins are controlled by PORT latches; UARTx power consumption is minimal
- bit 14      **Unimplemented:** Read as '0'
- bit 13      **USIDL:** UARTx Stop in Idle Mode bit  
 1 = Discontinues module operation when device enters Idle mode  
 0 = Continues module operation in Idle mode
- bit 12      **IREN:** IrDA<sup>®</sup> Encoder and Decoder Enable bit<sup>(2)</sup>  
 1 = IrDA encoder and decoder are enabled  
 0 = IrDA encoder and decoder are disabled
- bit 11      **RTSMD:** Mode Selection for  $\overline{\text{UxRTS}}$  Pin bit  
 1 =  $\overline{\text{UxRTS}}$  pin is in Simplex mode  
 0 =  $\overline{\text{UxRTS}}$  pin is in Flow Control mode
- bit 10      **Unimplemented:** Read as '0'
- bit 9-8      **UEN<1:0>:** UARTx Pin Enable bits  
 11 = UxTX, UxRX and BCLKx pins are enabled and used;  $\overline{\text{UxCTS}}$  pin is controlled by PORT latches<sup>(3)</sup>  
 10 = UxTX, UxRX,  $\overline{\text{UxCTS}}$  and  $\overline{\text{UxRTS}}$  pins are enabled and used<sup>(4)</sup>  
 01 = UxTX, UxRX and  $\overline{\text{UxRTS}}$  pins are enabled and used;  $\overline{\text{UxCTS}}$  pin is controlled by PORT latches<sup>(4)</sup>  
 00 = UxTX and UxRX pins are enabled and used;  $\overline{\text{UxCTS}}$  and  $\overline{\text{UxRTS}}$ /BCLKx pins are controlled by PORT latches
- bit 7      **WAKE:** Wake-up on Start bit Detect During Sleep Mode Enable bit  
 1 = UARTx continues to sample the UxRX pin; interrupt is generated on the falling edge; bit is cleared in hardware on the following rising edge  
 0 = No wake-up is enabled
- bit 6      **LPBACK:** UARTx Loopback Mode Select bit  
 1 = Enables Loopback mode  
 0 = Loopback mode is disabled

- Note 1:** Refer to the “**UART**” (DS70582) section in the “dsPIC33/PIC24 Family Reference Manual” for information on enabling the UARTx module for receive or transmit operation.
- 2:** This feature is only available for the 16x BRG mode (BRGH = 0).
- 3:** This feature is only available on 44-pin and 64-pin devices.
- 4:** This feature is only available on 64-pin devices.

**REGISTER 21-13: CxBUFPNT2: ECANx FILTER 4-7 BUFFER POINTER REGISTER 2**

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
F7BP<3:0>				F6BP<3:0>			
bit 15				bit 8			

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
F5BP<3:0>				F4BP<3:0>			
bit 7				bit 0			

**Legend:**

R = Readable bit                      W = Writable bit                      U = Unimplemented bit, read as '0'  
-n = Value at POR                      '1' = Bit is set                      '0' = Bit is cleared                      x = Bit is unknown

bit 15-12      **F7BP<3:0>**: RX Buffer Mask for Filter 7 bits  
1111 = Filter hits received in RX FIFO buffer  
1110 = Filter hits received in RX Buffer 14  
•  
•  
•  
0001 = Filter hits received in RX Buffer 1  
0000 = Filter hits received in RX Buffer 0  
bit 11-8      **F6BP<3:0>**: RX Buffer Mask for Filter 6 bits (same values as bits<15:12>)  
bit 7-4      **F5BP<3:0>**: RX Buffer Mask for Filter 5 bits (same values as bits<15:12>)  
bit 3-0      **F4BP<3:0>**: RX Buffer Mask for Filter 4 bits (same values as bits<15:12>)

**REGISTER 21-14: CxBUFPNT3: ECANx FILTER 8-11 BUFFER POINTER REGISTER 3**

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
F11BP<3:0>				F10BP<3:0>			
bit 15				bit 8			

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
F9BP<3:0>				F8BP<3:0>			
bit 7				bit 0			

**Legend:**

R = Readable bit                      W = Writable bit                      U = Unimplemented bit, read as '0'  
-n = Value at POR                      '1' = Bit is set                      '0' = Bit is cleared                      x = Bit is unknown

bit 15-12      **F11BP<3:0>**: RX Buffer Mask for Filter 11 bits  
1111 = Filter hits received in RX FIFO buffer  
1110 = Filter hits received in RX Buffer 14  
•  
•  
•  
0001 = Filter hits received in RX Buffer 1  
0000 = Filter hits received in RX Buffer 0  
bit 11-8      **F10BP<3:0>**: RX Buffer Mask for Filter 10 bits (same values as bits<15:12>)  
bit 7-4      **F9BP<3:0>**: RX Buffer Mask for Filter 9 bits (same values as bits<15:12>)  
bit 3-0      **F8BP<3:0>**: RX Buffer Mask for Filter 8 bits (same values as bits<15:12>)

## 23.0 10-BIT/12-BIT ANALOG-TO-DIGITAL CONVERTER (ADC)

**Note 1:** This data sheet summarizes the features of the dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X families of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to “**Analog-to-Digital Converter (ADC)**” (DS70621) in the “*dsPIC33/PIC24 Family Reference Manual*”, which is available from the Microchip web site ([www.microchip.com](http://www.microchip.com)).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

The dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X devices have one ADC module. The ADC module supports up to 16 analog input channels.

On ADC1, the AD12B bit (AD1CON1<10>) allows the ADC module to be configured by the user as either a 10-bit, 4 Sample-and-Hold (S&H) ADC (default configuration) or a 12-bit, 1 S&H ADC.

**Note:** The ADC module needs to be disabled before modifying the AD12B bit.

## 23.1 Key Features

### 23.1.1 10-BIT ADC CONFIGURATION

The 10-bit ADC configuration has the following key features:

- Successive Approximation (SAR) conversion
- Conversion speeds of up to 1.1 Msps
- Up to 16 analog input pins
- Connections to three internal op amps
- Connections to the Charge Time Measurement Unit (CTMU) and temperature measurement diode
- Channel selection and triggering can be controlled by the Peripheral Trigger Generator (PTG)
- External voltage reference input pins
- Simultaneous sampling of:
  - Up to four analog input pins
  - Three op amp outputs
  - Combinations of analog inputs and op amp outputs
- Automatic Channel Scan mode
- Selectable conversion Trigger source
- Selectable Buffer Fill modes
- Four result alignment options (signed/unsigned, fractional/integer)
- Operation during CPU Sleep and Idle modes

### 23.1.2 12-BIT ADC CONFIGURATION

The 12-bit ADC configuration supports all the features listed above, with the exception of the following:

- In the 12-bit configuration, conversion speeds of up to 500 ksps are supported
- There is only one S&H amplifier in the 12-bit configuration; therefore, simultaneous sampling of multiple channels is not supported.

Depending on the particular device pinout, the ADC can have up to 16 analog input pins, designated AN0 through AN15. These analog inputs are shared with op amp inputs and outputs, comparator inputs, and external voltage references. When op amp/comparator functionality is enabled, or an external voltage reference is used, the analog input that shares that pin is no longer available. The actual number of analog input pins, op amps and external voltage reference input configuration depends on the specific device.

A block diagram of the ADC module is shown in Figure 23-1. Figure 23-2 provides a diagram of the ADC conversion clock period.

**REGISTER 25-4: CMxMSKSRCA: COMPARATOR x MASK SOURCE SELECT  
CONTROL REGISTER (CONTINUED)**

bit 3-0      **SELSRCA<3:0>**: Mask A Input Select bits

1111 = FLT4  
1110 = FLT2  
1101 = PTGO19  
1100 = PTGO18  
1011 = Reserved  
1010 = Reserved  
1001 = Reserved  
1000 = Reserved  
0111 = Reserved  
0110 = Reserved  
0101 = PWM3H  
0100 = PWM3L  
0011 = PWM2H  
0010 = PWM2L  
0001 = PWM1H  
0000 = PWM1L



## **29.6 MPLAB X SIM Software Simulator**

The MPLAB X SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB X SIM Software Simulator fully supports symbolic debugging using the MPLAB XC Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

## **29.7 MPLAB REAL ICE In-Circuit Emulator System**

The MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs all 8, 16 and 32-bit MCU, and DSC devices with the easy-to-use, powerful graphical user interface of the MPLAB X IDE.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ-11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB X IDE. MPLAB REAL ICE offers significant advantages over competitive emulators including full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, logic probes, a ruggedized probe interface and long (up to three meters) interconnection cables.

## **29.8 MPLAB ICD 3 In-Circuit Debugger System**

The MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost-effective, high-speed hardware debugger/programmer for Microchip Flash DSC and MCU devices. It debugs and programs PIC Flash microcontrollers and dsPIC DSCs with the powerful, yet easy-to-use graphical user interface of the MPLAB IDE.

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

## **29.9 PICkit 3 In-Circuit Debugger/Programmer**

The MPLAB PICkit 3 allows debugging and programming of PIC and dsPIC Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB IDE. The MPLAB PICkit 3 is connected to the design engineer's PC using a full-speed USB interface and can be connected to the target via a Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the Reset line to implement in-circuit debugging and In-Circuit Serial Programming™ (ICSP™).

## **29.10 MPLAB PM3 Device Programmer**

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages, and a modular, detachable socket assembly to support various package types. The ICSP cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices, and incorporates an MMC card for file storage and data applications.

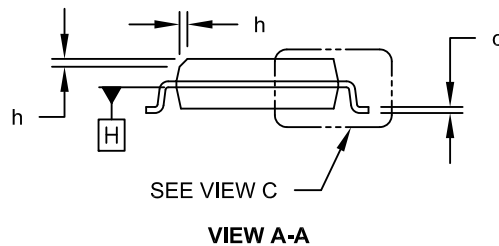
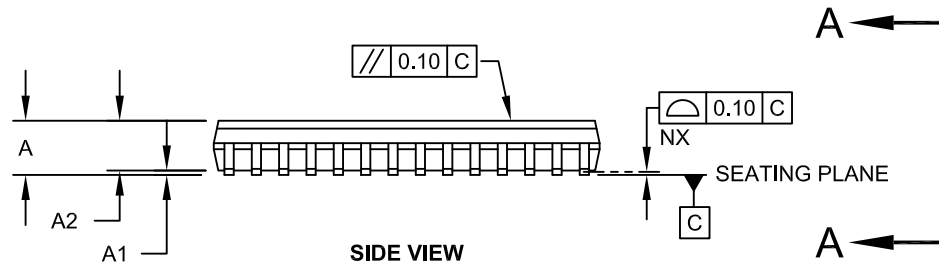
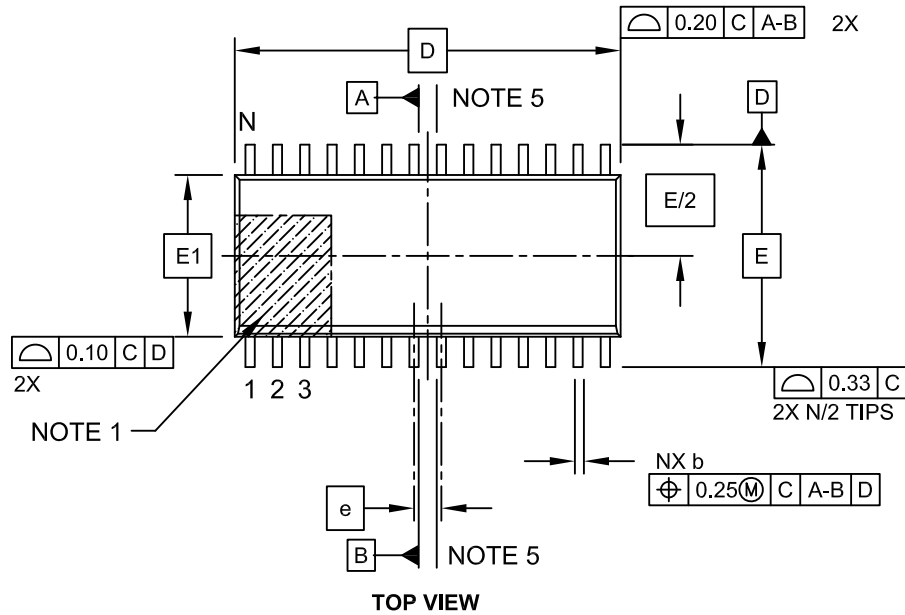
TABLE 30-11: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS (CONTINUED)

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for Extended				
Param No.	Symbol	Characteristic	Min.	Typ.	Max.	Units	Conditions
DI60a	I <sub>ICL</sub>	Input Low Injection Current	0	—	-5 <sup>(4,7)</sup>	mA	All pins except V <sub>DD</sub> , V <sub>SS</sub> , AV <sub>DD</sub> , AV <sub>SS</sub> , MCLR, VCAP and RB7
DI60b	I <sub>ICH</sub>	Input High Injection Current	0	—	+5 <sup>(5,6,7)</sup>	mA	All pins except V <sub>DD</sub> , V <sub>SS</sub> , AV <sub>DD</sub> , AV <sub>SS</sub> , MCLR, VCAP, RB7 and all 5V tolerant pins <sup>(6)</sup>
DI60c	$\Sigma I_{ICT}$	Total Input Injection Current (sum of all I/O and control pins)	-20 <sup>(8)</sup>	—	+20 <sup>(8)</sup>	mA	Absolute instantaneous sum of all $\pm$ input injection currents from all I/O pins ( $ I_{ICL}  +  I_{ICH} $ ) $\leq \Sigma I_{ICT}$

- Note 1:** The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current can be measured at different input voltages.
- 2:** Negative current is defined as current sourced by the pin.
- 3:** See the “Pin Diagrams” section for the 5V tolerant I/O pins.
- 4:** V<sub>IL</sub> source < (V<sub>SS</sub> – 0.3). Characterized but not tested.
- 5:** Non-5V tolerant pins V<sub>IH</sub> source > (V<sub>DD</sub> + 0.3), 5V tolerant pins V<sub>IH</sub> source > 5.5V. Characterized but not tested.
- 6:** Digital 5V tolerant pins cannot tolerate any “positive” input injection current from input sources > 5.5V.
- 7:** Non-zero injection currents can affect the ADC results by approximately 4-6 counts.
- 8:** Any number and/or combination of I/O pins not excluded under I<sub>ICL</sub> or I<sub>ICH</sub> conditions are permitted provided the mathematical “absolute instantaneous” sum of the input injection currents from all pins do not exceed the specified limit. Characterized but not tested.

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

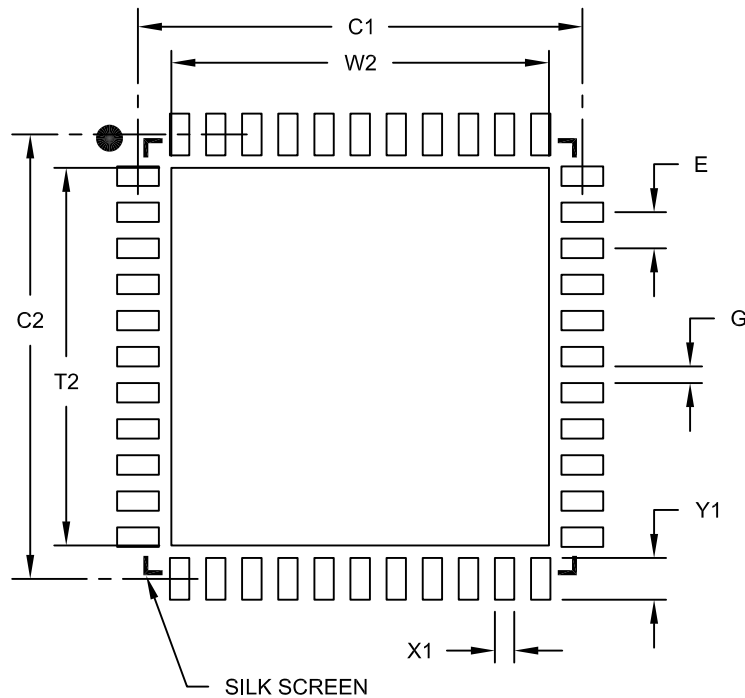
**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing C04-052C Sheet 1 of 2

44-Lead Plastic Quad Flat, No Lead Package (ML) - 8x8 mm Body [QFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



**RECOMMENDED LAND PATTERN**

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Optional Center Pad Width	W2			6.60
Optional Center Pad Length	T2			6.60
Contact Pad Spacing	C1		8.00	
Contact Pad Spacing	C2		8.00	
Contact Pad Width (X44)	X1			0.35
Contact Pad Length (X44)	Y1			0.85
Distance Between Pads	G	0.25		

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2103B

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

dsPIC 33 EP 64 MC5 04 T I / PT - XXX		
Microchip Trademark		
Architecture		
Flash Memory Family		
Program Memory Size (Kbyte)		
Product Group		
Pin Count		
Tape and Reel Flag (if applicable)		
Temperature Range		
Package		
Pattern		

<b>Architecture:</b>	33	=	16-bit Digital Signal Controller
	24	=	16-bit Microcontroller
<b>Flash Memory Family:</b>	EP	=	Enhanced Performance
<b>Product Group:</b>	GP	=	General Purpose family
	MC	=	Motor Control family
<b>Pin Count:</b>	02	=	28-pin
	03	=	36-pin
	04	=	44-pin
	06	=	64-pin
<b>Temperature Range:</b>	I	=	-40°C to +85°C (Industrial)
	E	=	-40°C to +125°C (Extended)
<b>Package:</b>	ML	=	Plastic Quad, No Lead Package - (44-pin) 8x8 mm body (QFN)
	MM	=	Plastic Quad, No Lead Package - (28-pin) 6x6 mm body (QFN-S)
	MR	=	Plastic Quad, No Lead Package - (64-pin) 9x9 mm body (QFN)
	MV	=	Thin Quad, No Lead Package - (48-pin) 6x6 mm body (UQFN)
	PT	=	Plastic Thin Quad Flatpack - (44-pin) 10x10 mm body (TQFP)
	PT	=	Plastic Thin Quad Flatpack - (64-pin) 10x10 mm body (TQFP)
	SO	=	Plastic Small Outline, Wide - (28-pin) 7.50 mm body (SOIC)
	SP	=	Skinny Plastic Dual In-Line - (28-pin) 300 mil body (SPDIP)
	SS	=	Plastic Shrink Small Outline - (28-pin) 5.30 mm body (SSOP)
	TL	=	Very Thin Leadless Array - (36-pin) 5x5 mm body (VTLA)
	TL	=	Very Thin Leadless Array - (44-pin) 6x6 mm body (VTLA)

### Examples:

dsPIC33EP64MC504-I/PT:  
dsPIC33, Enhanced Performance,  
64-Kbyte Program Memory,  
Motor Control, 44-Pin,  
Industrial Temperature,  
TQFP package.